SDLS139 - APRIL 1985 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

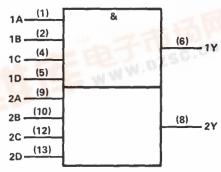
These devices contain two independent 4-input AND gates.

The SN54LS21 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74LS21 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

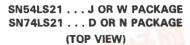
	INP	UTS	OUTPUT			
A	В	С	D	Y		
Н	Н	Н	н	H.		
L	X	X	X	L		
X	L	Х	X	L		
X	X	L	×	L		
X	X	X	L	L		
^	^	^	- 1	L		

logic symbol†



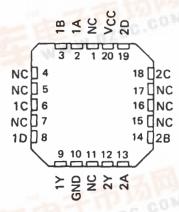
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.



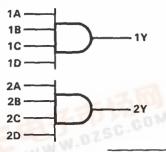
1A	d1	U14	VCC
1B	Q 2	13	2D
NC	\square_3	12	2C
1C	4	11	NC
1 D	₫5	10	2B
1Y	□6	е	2A
GND	d2	8	2Y

SN54LS21 . . . FK PACKAGE
(TOP VIEW)



NC-No internal connection

logic diagram

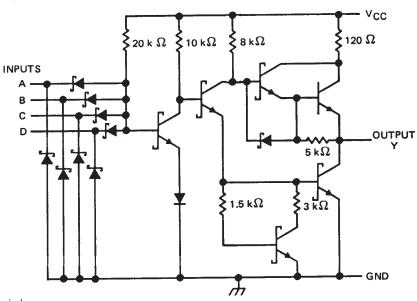


(positive logic) $Y = A \cdot B \cdot C \cdot D$ or $Y = \overline{A} + \overline{B} + \overline{C} + \overline{D}$

SN54LS21, SN74LS21 DUAL 4-INPUT POSITIVE-AND GATES

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schematics (each gate)



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		
Operating free-air temperature range:	SN54'	-55°C to 125°C
Storage temperature range		-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.



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recommended operating conditions

		SN54LS	521	SN74LS21			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	ONT
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	٧
VIH High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.7			0.8	٧
IOH High-level output current			- 0.4			- 0.4	mA
IOL Low-level output current			4			8	mA
T _A Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			SN54LS21			SN74LS21			
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
VIK	V _{CC} = MIN,	I _I = - 18 mA				- 1.5			1.5	٧
Voн	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OH} = - 0.4 mA	2.5	3.4		2.7	3.4		V
	V _{CC} = MIN,	VIL = MAX,	IOL = 4 mA		0.25	0.4		0.25	0.4	V
VOL	V _{CC} = MIN,	VIL = MAX,	I _{OL} = 8 mA					0.35	0.5	
11	V _{CC} = MAX,	V _I = 7 V				0.1			0.1	mA
Чн	V _{CC} = MAX,	V _I = 2.7 V				20			20	μА
I _Ι Γ	V _{CC} = MAX,	V ₁ = 0.4 V				- 0.4			- 0.4	mA
los§	V _{CC} = MAX			- 20		- 100	- 20		- 100	mA
Іссн	V _{CC} = MAX,	V ₁ = 4.5 V			1.2	2.4		1.2	2.4	mA
ICCL	V _{CC} = MAX,	V _I = 0 V			2.2	4.4		2.2	4.4	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS			TYP	MAX	UNIT
tPLH		.,	R _L = 2 kΩ,	C. = 15 oF		8	15	ns
tPHL	Any	Y		C _L = 15 pF		10	20	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



[§] Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

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